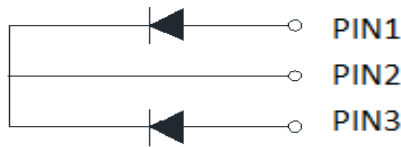
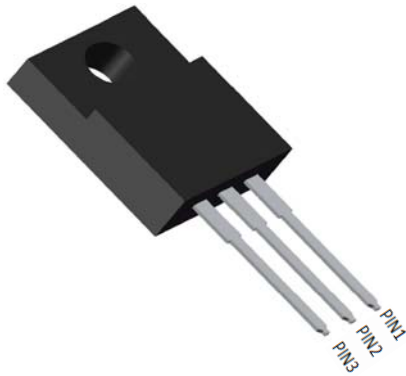


Schottky Diodes



Features

- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

Mechanical Data

- **Package:** ITO-220AB
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** As marked

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MBRU30100FCTA
Device marking code			MBRU30100FCTA
Repetitive Peak Reverse Voltage	V_{RRM}	V	100
Average Rectified Output Current @60Hz sine wave, R-load, Ta (FIG 1)	I_o	A	30
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, Ta=25°C	I_{FSM}	A	320
Current Squared Time @1ms≤t≤8.3ms Tj=25°C	I^2t	A ² s	425
Storage Temperature	T_{stg}	°C	-55 ~ +150
Junction Temperature	T_j	°C	-55 ~ +150

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	MBRU30100FCTA
Maximum instantaneous forward voltage drop per diode	V_{FM}	V	$I_{FM}=15.0A$	0.64
Maximum DC reverse current at rated DC blocking voltage per diode	I_{RRM1}	mA	$V_{RM}=V_{RRM}$ Ta=25°C	0.2
	I_{RRM2}		$V_{RM}=V_{RRM}$ Ta=100°C	100

■Thermal Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MBRU30100FCTA
Thermal Resistance Between junction and case	$R_{\theta J-C}$	°C/W	4.0



MBRU30100FCTA

Ordering Information (Example)

PREFERRED P/N	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
MBRU30100FCTA	Approximate 1.6	50	1000	5000	Tube

Characteristics (Typical)

FIG1:Io -Tc Curve

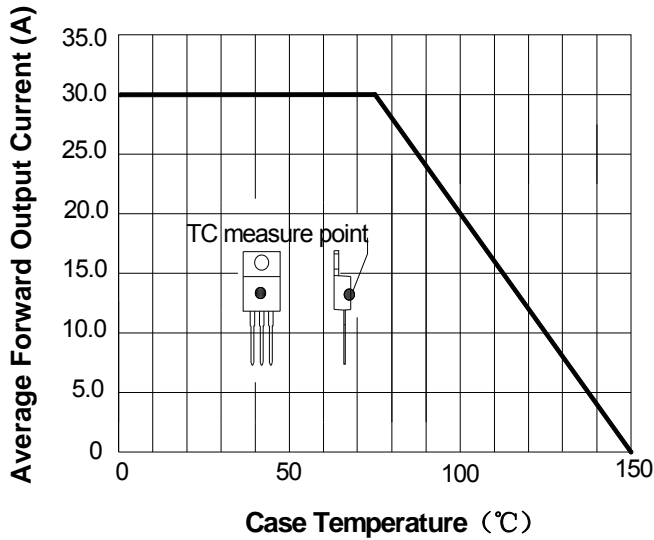


FIG2:Surge Forward Current Capability

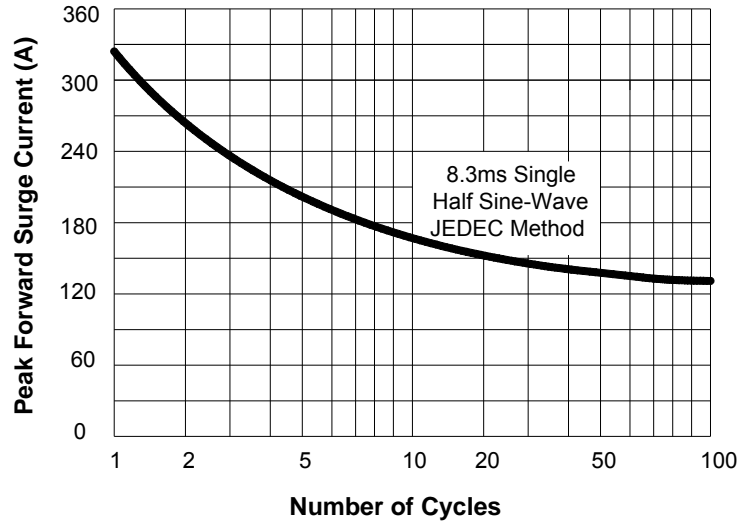


FIG3: Forward Voltage

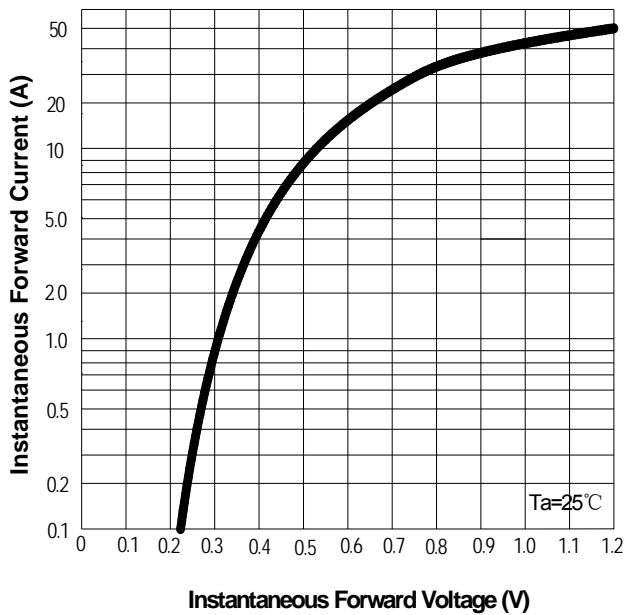
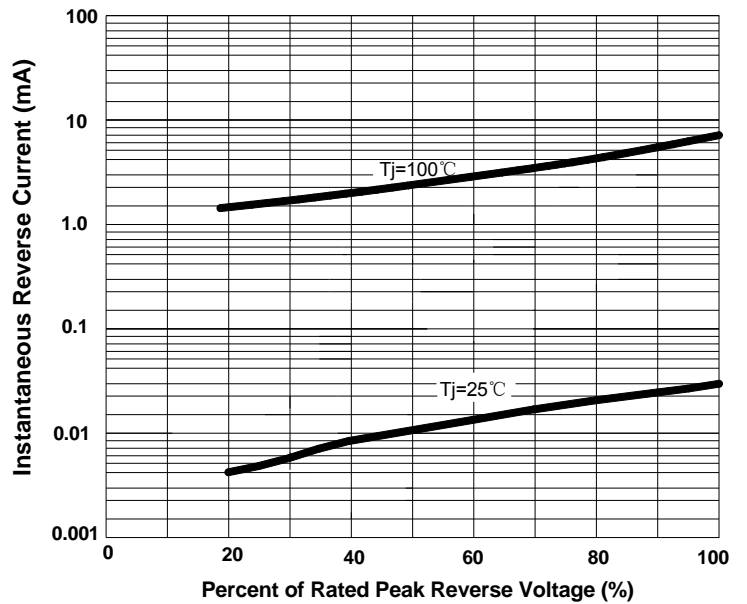
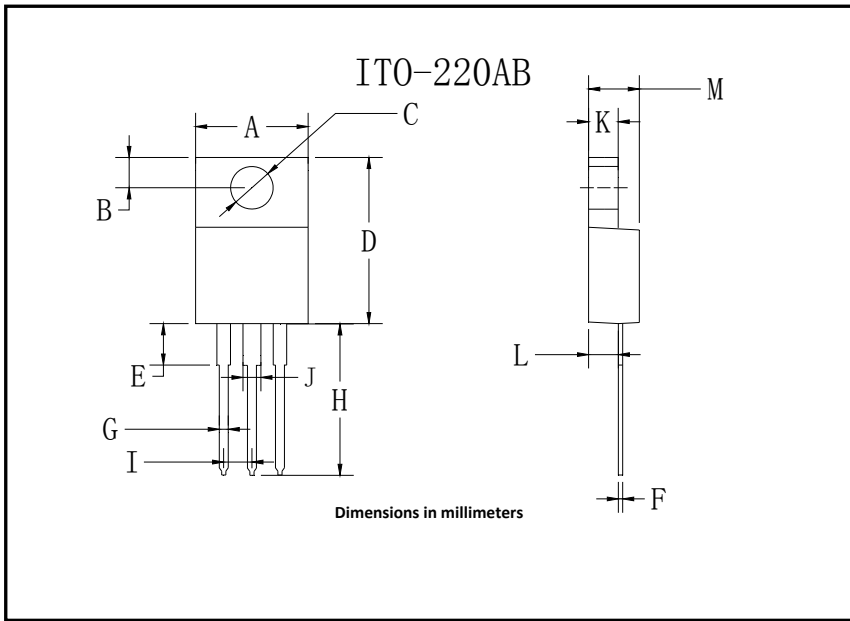


FIG.4: Typical Reverse Characteristics





■Outline Dimensions



ITO-220AB		
Dim	Min	Max
A	9.7	10.7
B	2.15	3.25
C	2.6	3.8
D	14.4	15.9
E	3.1	4.5
F	0.4	0.8
G	0.4	0.8
H	12.7	14.2
I	1.80	2.95
J	1.4	1.8
K	2.1	3.56
L	2.1	3.2
M	3.9	5.1



MBRU30100FCTA

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